2N3055(NPN), MJ2955(PNP)

Preferred Device

Complementary Silicon Power Transistors

Complementary silicon power transistors are designed for general-purpose switching and amplifier applications.

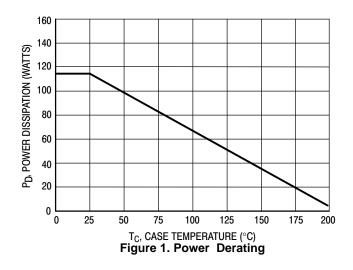
Features

- DC Current Gain $-h_{FE} = 20-70$ @ I_C = 4 Adc
- Collector–Emitter Saturation Voltage V_{CE(sat)} = 1.1 Vdc (Max) @ I_C = 4 Adc
- Excellent Safe Operating Area
- Pb–Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	60	Vdc
Collector-Emitter Voltage	V_{CER}	70	Vdc
Collector-Base Voltage	V _{CB}	100	Vdc
Emitter-Base Voltage	V _{EB}	7	Vdc
Collector Current – Continuous	Ι _C	15	Adc
Base Current	Ι _Β	7	Adc
Total Power Dissipation @ $T_C = 25^{\circ}C$ Derate Above $25^{\circ}C$	PD	115 0.657	W ₩/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



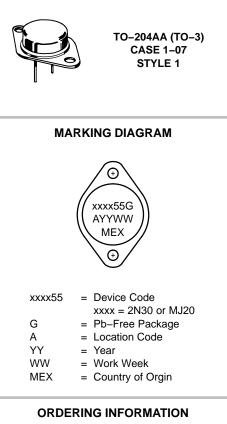
*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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15 AMPERE POWER TRANSISTORS COMPLEMENTARY SILICON 60 VOLTS, 115 WATTS



Device	Package	Shipping
2N3055	TO-204AA	100 Units / Tray
2N3055G	TO–204AA (Pb–Free)	100 Units / Tray
MJ2955	TO-204AA	100 Units / Tray
MJ2955G	TO–204AA (Pb–Free)	100 Units / Tray

Preferred devices are recommended choices for future use and best overall value.

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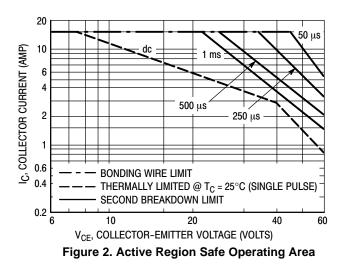
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ extsf{ heta}JC}$	1.52	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Мах	Unit
OFF CHARACTERISTICS*				-
Collector-Emitter Sustaining Voltage (Note 1) ($I_C = 200 \text{ mAdc}, I_B = 0$)	V _{CEO(sus)}	60	-	Vdc
Collector–Emitter Sustaining Voltage (Note 1) (I _C = 200 mAdc, R _{BE} = 100 Ω)	V _{CER(sus)}	70	-	Vdc
Collector Cutoff Current ($V_{CE} = 30 \text{ Vdc}, I_B = 0$)	I _{CEO}	-	0.7	mAdc
Collector Cutoff Current ($V_{CE} = 100 \text{ Vdc}, V_{BE(off)} = 1.5 \text{ Vdc}$) ($V_{CE} = 100 \text{ Vdc}, V_{BE(off)} = 1.5 \text{ Vdc}, T_C = 150^{\circ}C$)	I _{CEX}		1.0 5.0	mAdc
Emitter Cutoff Current (V_{BE} = 7.0 Vdc, I_C = 0)	I _{EBO}	-	5.0	mAdc
ON CHARACTERISTICS* (Note 1)				
DC Current Gain ($I_C = 4.0 \text{ Adc}, V_{CE} = 4.0 \text{ Vdc}$) ($I_C = 10 \text{ Adc}, V_{CE} = 4.0 \text{ Vdc}$)	h _{FE}	20 5.0	70 -	-
Collector-Emitter Saturation Voltage $(I_C = 4.0 \text{ Adc}, I_B = 400 \text{ mAdc})$ $(I_C = 10 \text{ Adc}, I_B = 3.3 \text{ Adc})$	V _{CE(sat)}	_	1.1 3.0	Vdc
Base–Emitter On Voltage (I_C = 4.0 Adc, V_{CE} = 4.0 Vdc)	V _{BE(on)}	-	1.5	Vdc
SECOND BREAKDOWN	•			-
Second Breakdown Collector Current with Base Forward Biased (V _{CE} = 40 Vdc, t = 1.0 s, Nonrepetitive)	I _{s/b}	2.87	-	Adc
DYNAMIC CHARACTERISTICS				
Current Gain – Bandwidth Product (I_C = 0.5 Adc, V_{CE} = 10 Vdc, f = 1.0 MHz)	f _T	2.5	_	MHz
*Small–Signal Current Gain (I_C = 1.0 Adc, V_{CE} = 4.0 Vdc, f = 1.0 kHz)	h _{fe}	15	120	-
*Small–Signal Current Gain Cutoff Frequency (V _{CE} = 4.0 Vdc, I _C = 1.0 Adc, f = 1.0 kHz)	f _{hfe}	10	-	kHz

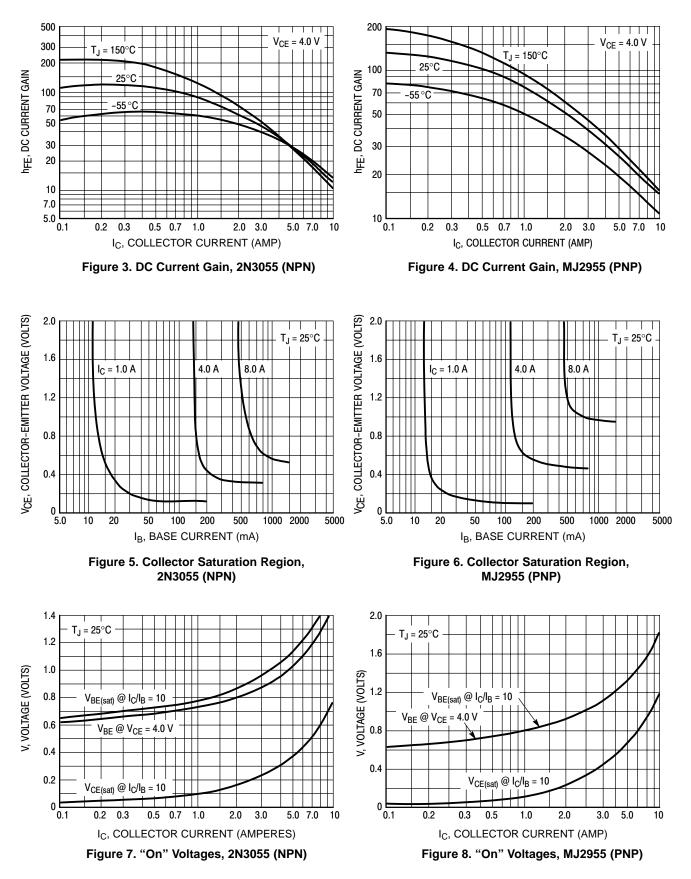
*Indicates Within JEDEC Registration. (2N3055) 1. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.



There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on $T_C = 25^{\circ}C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated for temperature according to Figure 1.

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



DIMENSIONS			
SCALE 1:1	TO–204 (TO–3) CASE 1–07 ISSUE Z		DATE 05/18/1988
$ \begin{array}{c} $		Y14.5M, 1982. 2. CONTROLLING DIM 3. ALL RULES AND N REFERENCED TO- INCHE: DIM MIN A A 1.550 RE B 1 C 0.250 0 D 0.038 0 E 0.055 0 G 0.430 BS H 0.215 BS K 0.440 0 L 0.665 BS N 0 Q 0.151 0 U 1.187 BS	OTES ASSOCIATED WITH 204AA OUTLINE SHALL APPLY. S MILLIMETERS MAX MAX #F 39.37 REF 050 043 0.97 043 0.97 070 1.40 1.77 C C 5.46 BSC 480 11.18 12.19 C 16.89 BSC 830 165 3.84 4.19
STYLE 1: PIN 1. BASE 2. EMITTER CASE: COLLECTOR	STYLE 2: STYLE 3: PIN 1. BASE PIN 1. GATE 2. COLLECTOR 2. SOURCE CASE: EMITTER CASE: DRAIN	STYLE 4: STYLE 5: PIN 1. GROUND PIN 1. CAT 2. INPUT 2. EXT CASE: OUTPUT CASE: ANG	FERNAL TRIP/DELAY
STYLE 6: PIN 1. GATE 2. EMITTER CASE: COLLECTOR	STYLE 7: STYLE 8: PIN 1. ANODE PIN 1. CATHODE #1 2. OPEN 2. CATHODE #2 CASE: CATHODE CASE: ANODE	STYLE 9: PIN 1. ANODE #1 2. ANODE #2 CASE: CATHODE	

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